



N-Channel 40-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
40	0.0023 at $V_{GS} = 10 \text{ V}$	1108		
	0.0038 at V _{GS} = 4.5 V	110 ^a		

FEATURES

- TrenchFET® Power MOSFET
- New Package with Low Thermal Resistance

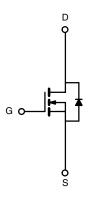


COMPLIANT



Ordering Information: SUM110N04-02L

SUM110N04-02L-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	iS T _C = 25 °C, unless o	therwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 20	_ v	
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	I-	110 ^a		
Continuous Diain Current (1j = 173 C)	T _C = 125 °C	I _D	110 ^a	A	
Pulsed Drain Current		I _{DM}	440	^	
Avalanche Current		I _{AR}	75		
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	280	mJ	
	T _C = 25 °C	D.	437.5 ^c	w	
Maximum Power Dissipation ^b	T _A = 25 °C	P _D	3.75	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	C/ VV

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).
- * Pb containing terminations are not RoHS compliant, exemptions may apply.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					Į.	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	40			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 125 °C			50	
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		0.00185	0.0023	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0031	0.0038	
		V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C			0.0037	
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.0046	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	30			S
Dynamic ^b	<u> </u>				· ·	
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		7300		pF
Output Capacitance	C _{oss}			1380		
Reverse Transfer Capacitance	C _{rss}			930		
Total Gate Charge ^c	Qg			165	250	nC
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 110 \text{ A}$		25		
Gate-Drain Charge ^c	Q_{gd}			55		
Turn-On Delay Time ^c	t _{d(on)}			30	45	ns ns
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V}, R_L = 0.27 \Omega$ $I_D \cong 110 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		80	120	
Turn-Off Delay Time ^c	t _{d(off)}			155	230	
Fall Time ^c	t _f			120	180	
Source-Drain Diode Ratings and Cha	aracteristics	Γ _C = 25 °C ^b				
Continuous Current	Is				110	
Pulsed Current	I _{SM}	И			240	A
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.1	1.5	V
Reverse Recovery Time	t _{rr}			60	90	ns
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 85 A, di/dt = 100 A/μs		2.6	4	Α
Reverse Recovery Charge	Q _{rr}			0.08	0.15	μС

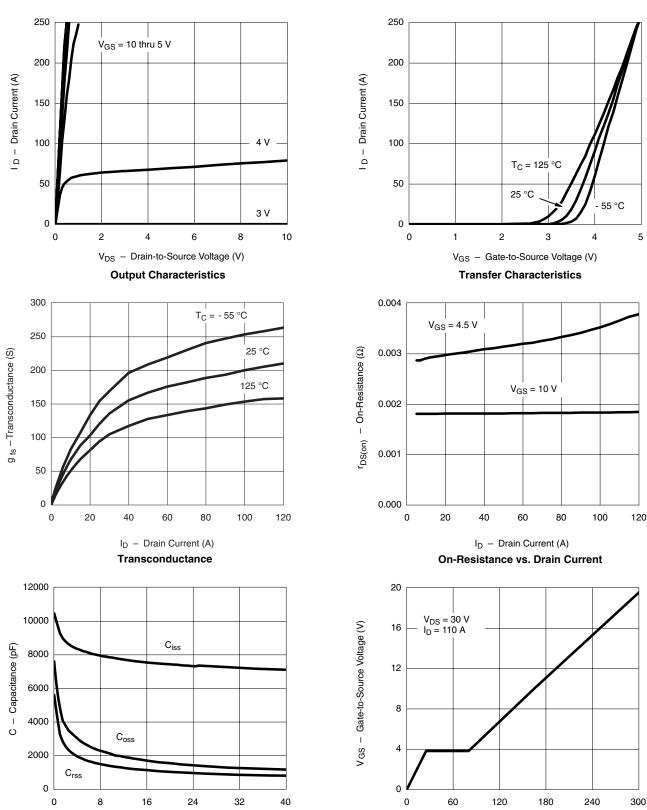
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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V_{DS} - Drain-to-Source Voltage (V)

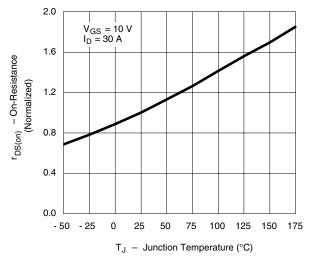
Capacitance

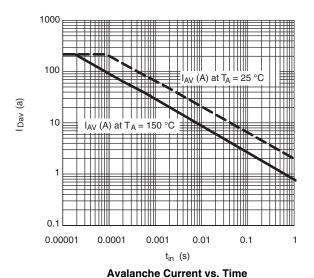
Q_g - Total Gate Charge (nC)

Gate Charge

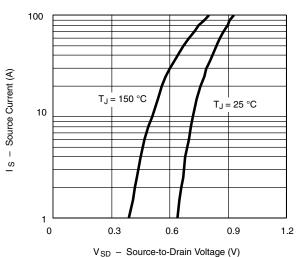
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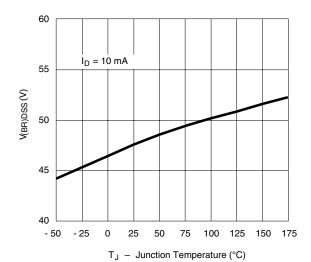




On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

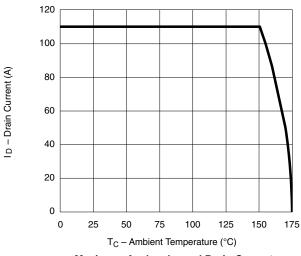


Drain Source Breakdown vs. Junction Temperature





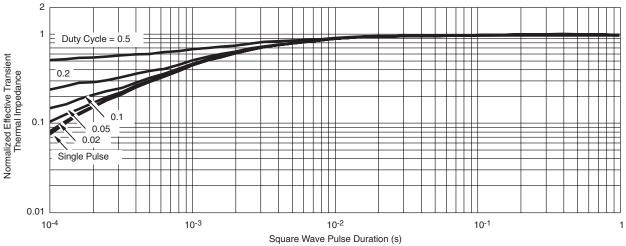
THERMAL RATINGS



1000 10 μs 100 100 μs ID - Drain Current (A) 1 ms 10 ms by r_{DS(on)} 10 100 ms DC $T_{C} = 25$ Single Pulse 0.1 0.1 10 100 V_{DS} - Drain-to-Source Voltage (V)

Maximum Avalanche and Drain Current vs. Case Temperature





Normalized Thermal Transient Impedance, Junction-to-Case

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